

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
TAI YEON LEE	07/28/2022
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<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	17637161
<b>CORRESPONDENCE DATA</b>	
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<b>ATTORNEY DOCKET NUMBER:</b>	2019P30330WOUS
<b>NAME OF SUBMITTER:</b>	/JED C BENSON/
<b>SIGNATURE:</b>	/Jed C Benson/
<b>DATE SIGNED:</b>	08/02/2022
<b>Total Attachments: 2</b>	
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**COMBINED DECLARATION AND ASSIGNMENT (37 CFR 1.63)**

As the below named inventor, I hereby declare that this Declaration is directed to:

TITLE: LIQUID, HYBRID UV/VIS RADIATION CURABLE RESIN COMPOSITIONS FOR ADDITIVE FABRICATION

the specification of which: (complete (a), (b) or (c))

(a)  is attached hereto.

(b)  was filed in the U.S. Patent & Trademark Office on February 22, 2022 and assigned Serial No. 17/637,161

(c)  was described and claimed in PCT International Application No. .... filed on .....

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

WHEREAS,

ASSIGNEE: Covestro (Netherlands) B.V., Urmonderbaan 22, Geleen 6167RD (hereinafter "Assignee")

desires to acquire the entire right, title, and interest in the application and invention, and to any United States patents to be obtained therefor

NOW, THEREFORE, for valuable consideration, receipt whereof is hereby acknowledged, I/We, the above named assignor(s), hereby sell, assign and transfer to the Assignee, its successors, legal representatives, and assigns, my/our entire right, title and interest, if any, in the invention and the application for the United States of America, including all direct and indirect divisions, continuations, and continuations-in-part thereof, and all original, extended, reissued, reviewed, and reexamined Letters Patent of the United States, and all countries foreign thereto, that may be granted thereon, including rights of priority under the International Convention of Paris (1883) as amended, including the right to claim priority under 35 U.S.C. §119, and I/we request the Director of the U.S. Patent and Trademark Office to issue any Letters Patent granted upon the invention set forth in the application to Assignee, its successors and assigns; and I/we hereby agree that Assignee may apply for foreign Letters Patent on the invention and I/we will without further consideration, communicate all facts know to me/us and execute without further consideration all papers deemed necessary by Assignee in connection with the United States and foreign applications when called upon to do so by Assignee, its successors, legal representatives, or assigns. I/We further represent and warrant that I/We have the full right to convey the interest assigned by this assignment, and that I/We have not granted any rights inconsistent with the rights granted herein. I/We further acknowledge an obligation of assignment of this invention to Assignee at the time the invention was made.

I hereby authorize and request the Patent Office Officials in the United States and its territorial possessions and any and all foreign countries to issue any and all of said Letters Patent, when granted, to Assignee as the assignee of my entire right, title and interest in and to the same, for the sole use and behoof of Assignee, its successors and assigns, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been held by me had this Assignment and sale not been made.


Further, I/We agree that I/We will testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal and reissue applications, execute all necessary assignment papers to cause any and all of said Letters Patent to be issued to Assignee, make all rightful oaths, and, generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper protection for said invention in the United States and its territorial possessions and in any and all foreign countries.

I/We hereby state that I/We have reviewed and understand the contents of the above identified application, including the claims, as amended by any amendment specifically referred to above.

I/We acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56, including for continuation-in-part applications, material information which became available between the filing date of the prior application and the national or PCT international filing date of the continuation-in-part application.

I/We hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application

**1. INVENTOR:** Tai Yeon LEE

Signature: /   
Tai Yeon Lee (Jul 28, 2022 08:58 GMT) / Date: / 28-Jul-2022 /